



IQS211A Datasheet

Single Channel Capacitive Proximity/Touch Controller with movement detection

The IQS211A ProxSense[®] IC is a self-capacitance controller designed for applications where an awake/activate on proximity/touch function is required. The IQS211A is an ultra-low power solution that uses movement detection for applications that require long term detection. The IQS211A operates standalone or I²C and can be configured via OTP (One Time Programmable) bits.

Features

- Pin compatible with IQS127/128/227/228
- Automatic Tuning Implementation (ATI)
- On-chip movement detection algorithm
- Forced activation when movement detected
- Minimal external components
- 25mm detection distance
- Up to 60pF sensor load (with effective movement detection)
- Multiple One-Time-Programmable (OTP) options
- Standalone direct outputs:
 - Primary output (configurable) Default: **ACTIVATION**
 - Secondary output (configurable)
 Default: MOVEMENT
- 1-Wire streaming interface:
 - 1-Wire & event CLK signal
 - Valuable for debugging &
- Special configurations:
 - o Activation based on capacitive load at

Applications

- Wearable devices
- Movement detection devices (fitness, anti-theft)
- White goods and appliances

RoHS2 compliant 6 pin TSOT23-6 Representations only, not actual markings

power-on

Separate MOVEMENT output selection: Pulse Frequency Modulation



(PFM, default), Pulse Width Modulation (PWM), Latched, or PWM only active in activation

- Low power consumption: 80uA (50 Hz response), 20uA (20 Hz response) and 2uA (LP mode, optional zoom to scanning mode with wake-up)
- Low power options:
 - Low power without activation
 - o Low power within activation
 - Low power standby modes with proximity wake-up / reset wake-up
- Internal Capacitor Implementation (ICI)
- Supply voltage: 1.8V to 3.3V
- Low profile TSOT23-6 package
 - Human Interface Devices
 - Proximity activated backlighting
 - Applications with long-term activation

Available Packages				
T _A	TSOT23-6			
-20°C to 85°C	IQS211A			





1 Packaging and Pin-Out

The IQS211A is available in a TSOT23-6 package.



Figure 1.1 IQS211A pin-out (TSOT23-6 package)

Table 1.1 Pin-out description

	IQS211A in TSOT23-6					
Pin	Name Type		Function			
1	PRIMARY I/O	Digital Input/Output	Multifunction IO1 / SCL (I ² C Clock signal) / 1WIRE (data streaming)			
2	VSS	Signal GND				
3	SECONDARY I/O	Digital Input/Output	Multifunction IO2 / SDA (I ² C Data output)			
4	VREG	Regulator output	Requires external capacitor			
5	VDDHI	Supply Input	Supply:1.8V – 3.6V			
6	Сх	Sense electrode	Connect to conductive area intended for sensor			
	R U1 VDDHI IC GND GND	CX 6 DI/SCL/IWIRE 1 IO1/SCL/DATA 1 IO2/SDA/EVENT VREG VREG VREG C1 C1 C1 C2 GND GND GND	CS 10pF VDDHI 470R CX VDDHI 470R DS0 IO2/SDA/EVENT DS1 IO1/SCL/DATA VDDHI R5 470R VDDHI R5 470R VDDHI R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 4477 R7 101/SCL/DATA			

Figure 1.2 IQS211A reference schematic

OI01/SCL/DATA

O IO2/SDA/EVENT

Figure 1.2 shows the following:

• Schematic for default power mode, see guide for capacitor selection in low power modes below:

Low power scan time	8ms (default) - 32ms	64ms	128ms	256ms
Capacitor recommendation	C1 = 1µF	C1 = 1µF	C1 = 2.2µF	C1 = 4.7µF
	C3 = 1µF	C3 = 2.2µF	C3 = 4.7µF	C3 = 10µF

- C5 = 10pF load. This can be changed for slight variations in sensitivity. The recommended value is 1pF to 60pF, depending on the capacitance of the rest of the layout.
- R1 = 470Ω 0603 for added ESD protection





 * R2: Place a 40Ω resistor in the VDDHI supply line to prevent a potential ESD induced latch-up. Maximum supply current should be limited to 80mA on the IQS211A VDDHI pin to prevent latch-up.



Figure 1.3 IQS211A reference schematic for ultra-low power (ULP) modes with VREG damping through IO2 selected (OTP bank3:bit3)





2 Configuration Options

The IQS211A offers various user selectable options. These options may be selected via I²C setup or one-time programmable (OTP) configuration. OTP settings may be ordered preprogrammed for bulk orders or in-circuit programming techniques may be implemented during the product testing phase. I²C setup allows access to all device settings while entering direct output mode as soon as selected by the MCU.

Azoteq offers a Configuration Tool (CT210 or later) and associated software that can be used to program the OTP user options for prototyping purposes. For further information regarding this subject, please contact your local distributor or submit enquiries to Azoteq at: <u>ProxSenseSupport@azoteq.com</u>





2.1 User Selectable OTP options

OTP bank	0		IQS211A	000000 <u>xx</u> T	SR (ordering c	ode)	
Bit7	6	5 Scan timos	4	3 Prox wake up	2	1	Bit 0
multiplier	ensitivity	Scantimes		FIOX wake-up	LOW	-power scan time	;
00 - 150 01 - 10 - 1 11 - 2	counts / 0 Idle / Active 0 – Active 000 - 9ms 75 / 1 00 - 9/9ms direction 001 - 32ms 00 / 2 01 - 9/64 010 - 64ms 200 / 3 10 - 32/32 1 – Both 011 - 96ms 11 - 32/64 directions 100- 128ms 101 - 160ms 110 - 192ms						
OTP Bank	1		IQS211A	0000 xx 00 T	SR		
Bit7	6	5	4	3	2	1	Bit 0
Touch late release (50%)	Filter halt / Wak	e-up threshold	Touch thresho	ld		Movement three	shold
0 – Disabled 1 – Enabled	00 – 4 counts 01 – 2 (+2 LP) 10 – 8 (+2 LP) 11 – 16 (+2 LP)	(+2 LP)	000 - 6/256 of 001 - 2/256 010 - 16/256 011 - 32/256 100 - 48/256 101 - 64/256 110 - 80/256 111 - 96/256	LTA		00 – 3 counts 01 – 6 10 – 15 11 – 2	
OTP Bank	2		IQS211A	00 <u>xx</u> 0000 T	SR		
Bit7	6	5	4	3	2	1	Bit 0
Reseed after no	o movement time		Movement out	put type	Output / User interf	ace selection	
000 - 2s 001 - 5s 010 - 20s 011 - 1min 100 - 2min 101 - 10min 110 - 60min 111 - always halt		00 -Normal (PFM)000 -Activation (IO01 - PWM001 -Movement La10 - Constant Movement , clears upon no movement timeout010 - Movement (IO11 - PFM combined with activation output100 - 1Wire (IO1)11 - I2C (polling)110 - I2C with res111 - I2C (polling)		1) & Movement(IO2) atch(IO1) and Movement (IO2) O1) & Input(IO2) , Prox (IO2) & Clk (IO2) (only on events) no wakeup set indication+RDY toggle on SCL + Wakeup + RDY toggle on SCL			
OTP Bank	3		IQS211A	0 <u>x</u> 000000 T	SR		
Bit7	6	5	4	3	2	1	Bit 0
Reserved				VREG damping through IO2	AC Filter	Halt charge / Reseed on IO1	IO1 (output) / IO2 (input) definition
				0 – Disabled 1 – Enabled	0 – Normal 1 – Increased	0 – Disabled 1 – Enabled	0 – Normal / Halt charge 1 – PWM / Reduce sensitivity
OTP Bank 4 IQS211A <u>x</u> 0000000 TSR							
Bit7	6	5	4	3	2	1	Bit 0
Reserved				ATI partial	Auto activation (when compensation multiplier > 7)	ATI target	
				0 – Disabled 1 – Enabled	0 – Disabled 1 – Enabled	00 – 768 counts 01 – 1200 10 – 384 11 – 192	S





2.2 I2C registers

Table 2.1 I2C communications layout

	I2C Communications Layout										
Address/ Command/ Byte	Register name/s	R/W	Default Value	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
00H	PRODUCT NUM	R	0x3D					1			
01H	VERSION NUM	R	0x01								
10H	<u>SYSFLAGS0</u>	R/W		Movement	Movement Constant	PROX	TOUCH	Show Reset	ATI Busy	Filter Halt	LP Active
41H	Movement Value	R									
42H	<u>CS H</u>	R									
43H	<u>CS L</u>	R									
83H	LTA H	R									
84H	LTA L	R									
90H	Touch Threshold H										
91H	Touch Threshold L										
C4H	MULTIPLIERS	R/W		n/a	n/a	n1	n0	p3	p2	p1	p 0
C5H	<u>COMPENSATION</u>	R/W					0-255				
СбН	PROX SETTINGSO	R/W		Base Value P 00 01 10 11	e/ SensMult for artial: - 150/0 - 100/1 - 200/2 - 250/3	Reseed	Redo ATI	Active Sc 000 – 8ms 001 - +32 010 - +64 011 - +256	an Time (normal) ms Sleep ms Sleep ims Sleep	Idle Sc 000 – 8m 001 - +32 010 - +64 011 - +25	an time s (normal) 2ms Sleep 4ms Sleep 6ms Sleep
С7Н	PROX_SETTINGS1 PROX_SETTINGS2	R/W R/W		0 – Auto reseed is in seconds 1 – Auto reseed is in minutes 0 – Prox Timeout of 2s 1 – Prox timeout of 20s	If UI type 011: 0- Halt charge/Reseed 1- Reduce sensitivity If UI type 000: 0- Normal 1- PWM touch out n/a	Halt Charge/Reseed on IO1, with IO1 set as output AUTO Activation on start up	00-Nc 01 10- Movemer no move: 11-PFM activat	rmal (PFM) – PVM Constant t, clears upon ment timeout combined with cion output Touch Late Release (50%)	000 – Activa 001 – Mo 010 – Mo 011 – T 100 – IWir 101 – I 110 - I2C v 111 – I2C Partial ATI enabled	tion(IO1) & Mo vovement Latch Vovement (IO2) vement(IO1) & Fouch (IO1), Prr e (IO1) & Clk (III events) 2C (polling) no with reset indic toggle on SCL (polling) + Wak toggle on SCL Auto ATI off	vement(IO2) (IO1) and 2) Input(IO2) xx (IO2) D2) (only on wakeup ation +RDY seup + RDY Increase AC filters, increase touch threshold with 10counts, halt with
COL		D/M					V * 0 = ATI +	argot			4
Сэп		R/W					* 16ms = clo	aigel en time			
САП		R/W				x		cp time			
ССН	TOUCH THRESHOLD	R/W									
CDH	MOVEMENT THRESHOLD	R/W		1							
CEH	AUTO RESEED LIMIT	R/W		in Seconds or Minutes, based on PROX_SETTINGS1 bit 7.							





3 Specifications

3.1 Absolute maximum ratings

The following absolute maximum parameters are specified for the device:

Exceeding these maximum specifications may cause damage to the device.

- Operating temperature
- Supply Voltage (VDDHI VSS)
- Maximum pin voltage
- Maximum continuous current (for specific Pins)
- Minimum pin voltage
- Minimum power-on slope
- ESD protection
- Package Moisture Sensitivity Level (MSL)

-20°C to 85°C 3.6V VDDHI + 0.5V (may not exceed VDDHI max) 10mA VSS – 0.5V 100V/s ±8kV (Human body model) 1

Table 3.1 IQS211A General Operating Conditions

DESCRIPTION	Conditions	PARAME TER	MIN	ТҮР	MAX	UNIT
Supply voltage		V _{DDHI}	1.8	3.3V	3.6	V
Internal regulator output	$1.8 \le V_{DDHI} \le 3.6$	V_{REG}	1.62	1.7	1.79	V
Default Operating Current	3.3V, Scan time = 9	I _{IQS211DP}		77	88	μA
Low Power Example Setting 1*	3.3V, Scan time =160	I _{IQS211LP160}			2**	μΑ

*Scan time in ms

**Defined for low target counts (192)

Table 3.2 Start-up and shut-down slope Characteristics

DESCRIPTION	Conditions	PARAMETER	MIN	MAX	UNIT
Power On Reset	V _{DDHI} Slope ≥ 100V/s @25°C	POR	1.2	-	V
Brown Out Detect	V _{DDHI} Slope ≥ 100V/s @25°C	BOD	-	1.5	V

Table 3.3 Input signal response characteristics (IO1/IO2)

DESCRIPTION	MIN	ΤΥΡ	MAX	UNIT
Reseed function	15	20	25	ms
Halt charge / Reduce sensitivity function	50	n/a	n/a	ms

Table 3.4 Communications timing characteristics

DESCRIPTION	MIN	TYP	MAX	UNIT
t _{comms_timeout}	-	20	-	ms





Table 3.5 Digital input trigger levels

DESCRIPTION	Conditions	PARAMETER	MIN	TYPICAL	MAX	UNIT
All digital inputs	VDD = 3.3V	Input low level voltage	1.19	1.3	1.3	V
All digital inputs	VDD = 1.8V	Input low level voltage	0.54	0.6	0.76	V
All digital inputs	VDD = 1.8V	Input high level voltage	0.9	1.0	1.2	V
All digital inputs	VDD = 3.3V	Input high level voltage	1.90	2.1	2.20	V





4 Package information

4.1 TSOT23-6





Figure 4.1 TSOT23-6 Packagingⁱ

Table 4.1 TSOT23-6 Dimensions

Dimension	Min (mm)	Max (mm)		
А	2.60	3.00		
В	1.50	1.70		
С	2.80	3.00		
D	0.30	0.50		
Е	0.95 Basic			
F	0.84	1.00		
G	0.00	0.10		
Н	0.30	0.50		
I	0°	8°		
J	0.03	0.20		

ⁱ Drawing not on Scale





4.2 MSL Level

Moisture Sensitivity Level (MSL) relates to the packaging and handling precautions for some semiconductors. The MSL is an electronic standard for the time period in which a moisture sensitive device can be exposed to ambient room conditions (approximately 30°C/85%RH see J-STD033C for more info) before reflow occur.

Package	Level (duration)
TEOTOS	MSL 1 (Unlimited at ≤30 °C/85% RH)
150123-6	Reflow profile peak temperature < 260 °C for < 30 seconds





5 Ordering and Part-number Information

5.1 Ordering Information

Please check stock availability with your local distributor.



	1002111		Salf Canacitiva Tayoh IC
IC NAME	IQ5211A	=	Sell Capacitive Touch IC
CONFIGURATION	ZZZ ZZZ ZZ	=	IC configuration (hexadecimal)
			Default 000 000 (other configurations
			Default 000 000 00 (other configurations
			available on request)
PACKAGE TYPE	TS	=	TSOT23-6 package
BULK PACKAGING	R	=	Reel (3000pcs/reel) – MOQ = 3000pcs
			MOQ = 1 reel (orders shipped as full reels)

5.2 Label Information

REVISION	Х	=	IC Revision Number
TEMPERATURE RANGE	t	=	-20°C to 85°C (Industrial)
DATE CODE	Ρ	=	Internal use
	WWYY=		Batch number





5.3 Device Marking – Top

There are 2 marking versions for IQS211A:



Figure 5.1 IQS211A engineer version, marked as 221A.



Figure 5.2 Production version marking of IQS211A.

IC NAME	221A ENG	=	IQS211A Engineering version
	211A	=	IQS211A Production version
Batch Code	XX	=	AA to ZZ

5.4 Device Marking - Bottom

Some batches IQS211A will not have any bottom markings. These devices are configured after marking, and may have variations in configuration – please refer to the reel label.

Other batches will display the version and unique product code on the chip on the bottom marking.



TSOT23-6 Tape Specification





Revision History

Revision Number	Description	Date of issue
V0.9	IQS211A preliminary datasheet	23 November 2015
V1.0	First release	December 2015
V1.01	Updated Ordering information and Marking	December 2015
V1.10	Latch-up prevention details added	September 2016
V1.2	Temperature range updated	28 September 2017





Appendix A Contact Information

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Please visit **www.azoteq.com** for a list of distributors and worldwide representation.

The following patents relate to the device or usage of the device: US 6,249,089; US 6,952,084; US 6,984,900; US 7,084,526; US 7,084,531; US 8,395,395; US 8,531,120; US 8,659,306; US 8,823,273; US 9,209,803; US 9,360,510; EP 2,351,220; EP 2,559,164; EP 2,656,189; HK 1,156,120; HK 1,157,080; SA 2001/2151; SA 2006/05363; SA 2014/01541; SA 2015/023634

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